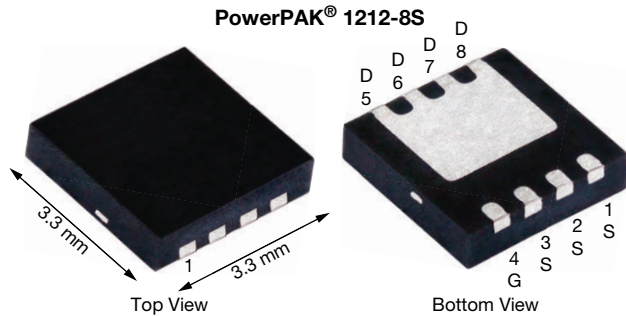


## N-Channel 30 V (D-S) MOSFET with Schottky Diode



PRODUCT SUMMARY	
$V_{DS}$ (V)	30
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 10$ V	0.00131
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 4.5$ V	0.00201
$Q_g$ typ. (nC)	25.9
$I_D$ (A)	181.8
Configuration	Single

### FEATURES

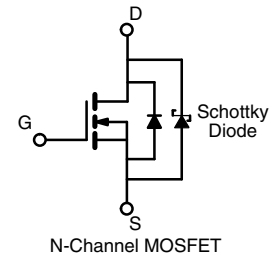
- TrenchFET® Gen IV power MOSFET
- SKYFET® with monolithic Schottky diode
- Optimized  $R_{DS} \times Q_g$  and  $R_{DS} \times Q_{gd}$  FOM enable higher efficiency for high frequency switching
- 100 %  $R_g$  and UIS tested
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



**RoHS**  
COMPLIANT  
HALOGEN  
FREE

### APPLICATIONS

- Synchronous rectification
- Synchronous buck converter
- DC/DC conversions



N-Channel MOSFET

ORDERING INFORMATION	
Package	PowerPAK 1212-8S
Lead (Pb)-free and halogen-free	SiSS60DN-T1-GE3

ABSOLUTE MAXIMUM RATINGS ( $T_A = 25$ °C, unless otherwise noted)				
PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage		$V_{DS}$	30	V
Gate-source voltage		$V_{GS}$	+16 / -12	
Continuous drain current ( $T_J = 150$ °C)	$T_C = 25$ °C	$I_D$	181.8	A
	$T_C = 70$ °C		145.4	
	$T_A = 25$ °C		50.1 <sup>b, c</sup>	
	$T_A = 70$ °C		40.1 <sup>b, c</sup>	
Pulsed drain current ( $t = 100$ $\mu$ s)		$I_{DM}$	200	
Continuous source-drain diode current	$T_C = 25$ °C	$I_S$	97.5	
	$T_A = 25$ °C		8.5 <sup>b, c</sup>	
Single pulse avalanche current	L = 0.1 mH	$I_{AS}$	20	mJ
Single pulse avalanche energy		$E_{AS}$	20	
Maximum power dissipation	$T_C = 25$ °C	$P_D$	65.8	W
	$T_C = 70$ °C		42.1	
	$T_A = 25$ °C		5.1 <sup>b, c</sup>	
	$T_A = 70$ °C		3.2 <sup>b, c</sup>	
Operating junction and storage temperature range		$T_J, T_{stg}$	-55 to +150	°C
Soldering recommendations (peak temperature) <sup>c</sup>			260	

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum junction-to-ambient <sup>b</sup>	$t \leq 10$ s	$R_{thJA}$	20	25	°C/W
Maximum junction-to-case (drain)	Steady state	$R_{thJC}$	1.5	1.9	

#### Notes

- $T_C = 25$  °C
- Surface mounted on 1" x 1" FR4 board
- $t = 10$  s
- See solder profile ([www.vishay.com/doc?73257](http://www.vishay.com/doc?73257)). The PowerPAK 1212-8S is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
- Rework conditions: manual soldering with a soldering iron is not recommended for leadless components
- Maximum under steady state conditions is 63 °C/W



SPECIFICATIONS (T <sub>J</sub> = 25 °C, unless otherwise noted)							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
<b>Static</b>							
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA	30	-	-	V	
Gate-source threshold voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250 μA	1	-	2.5	V	
Gate-source leakage	I <sub>GSS</sub>	V <sub>DS</sub> = 0 V, V <sub>GS</sub> = +16 V / -12 V	-	-	100	nA	
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 0 V	-	-	300	μA	
		V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 70 °C	-	-	5	mA	
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	V <sub>DS</sub> ≤ 10 V, V <sub>GS</sub> = 10 V	20	-	-	A	
Drain-source on-state resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 20 A	-	0.00109	0.00131	Ω	
		V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 15 A	-	0.00155	0.00201		
Forward transconductance <sup>a</sup>	g <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 20 A	-	84	-	S	
<b>Dynamic <sup>b</sup></b>							
Input capacitance	C <sub>ISS</sub>	V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 0 V, f = 1 MHz	-	3960	-	pF	
Output capacitance	C <sub>OSS</sub>		-	1785	-		
Reverse transfer capacitance	C <sub>RSS</sub>		-	142	-		
Total gate charge	Q <sub>g</sub>	V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 50.1 A	-	57	85.5	nC	
		V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 50.1 A	-	25.9	38.9		
Gate-source charge	Q <sub>gs</sub>		-	12.6	-		
Gate-drain charge	Q <sub>gd</sub>		-	5.6	-		
Output charge	Q <sub>OSS</sub>		V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 0 V	-	46		69
Gate resistance	R <sub>g</sub>	f = 1 MHz	0.12	0.6	1.2		Ω
Turn-on delay time	t <sub>d(on)</sub>	V <sub>DD</sub> = 15 V, R <sub>L</sub> = 0.374 Ω, I <sub>D</sub> ≅ 40.1 A, V <sub>GEN</sub> = 10 V, R <sub>g</sub> = 1 Ω	-	18	36	ns	
Rise time	t <sub>r</sub>		-	7	14		
Turn-off delay time	t <sub>d(off)</sub>		-	30	60		
Fall time	t <sub>f</sub>		-	6	12		
Turn-on delay time	t <sub>d(on)</sub>	V <sub>DD</sub> = 15 V, R <sub>L</sub> = 0.374 Ω, I <sub>D</sub> ≅ 40.1 A, V <sub>GEN</sub> = 4.5 V, R <sub>g</sub> = 1 Ω	-	30	60		
Rise time	t <sub>r</sub>		-	265	530		
Turn-off delay time	t <sub>d(off)</sub>		-	40	80		
Fall time	t <sub>f</sub>		-	18	36		
<b>Drain-Source Body Diode Characteristics</b>							
Continuous source-drain diode current	I <sub>S</sub>	T <sub>C</sub> = 25 °C	-	-	97.5		A
Pulse diode forward current	I <sub>SM</sub>		-	-	200		
Body diode voltage	V <sub>SD</sub>	I <sub>S</sub> = 10 A, V <sub>GS</sub> = 0 V	-	0.45	0.68	V	
Body diode reverse recovery time	t <sub>rr</sub>	I <sub>F</sub> = 10 A, di/dt = 100 A/μs, T <sub>J</sub> = 25 °C	-	45	90	ns	
Body diode reverse recovery charge	Q <sub>rr</sub>		-	43	86	nC	
Reverse recovery fall time	t <sub>a</sub>		-	22	-	ns	
Reverse recovery rise time	t <sub>b</sub>		-	23	-		

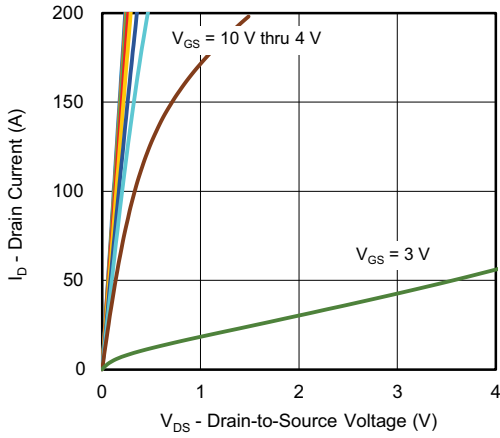
**Notes**

- a. Pulse test; pulse width ≤ 300 μs, duty cycle ≤ 2 %
- b. Guaranteed by design, not subject to production testing

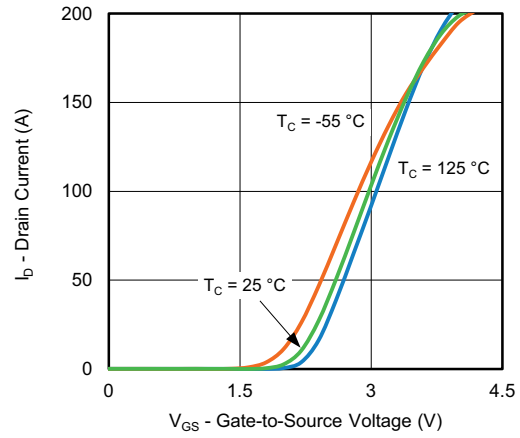
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



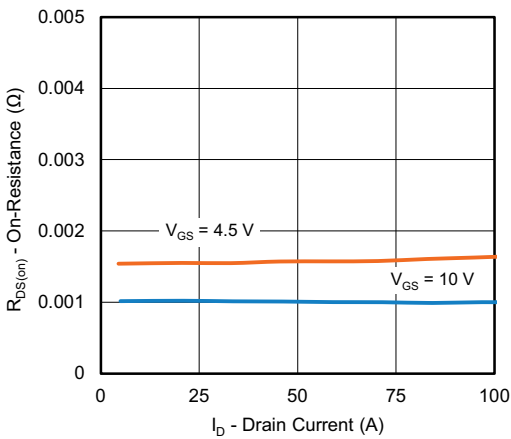
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



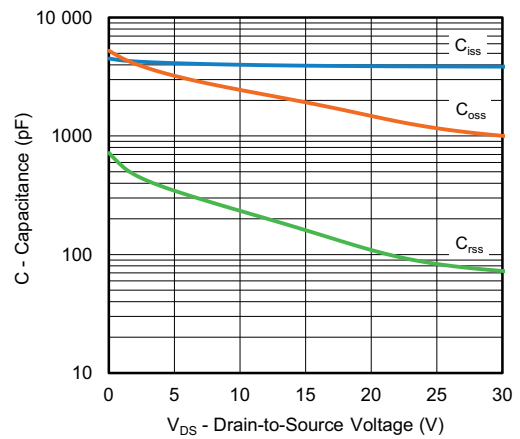
Output Characteristics



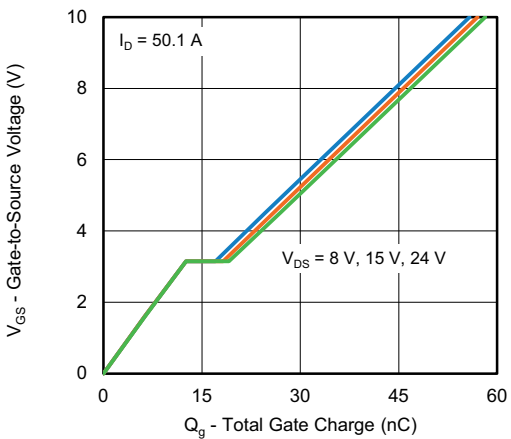
Transfer Characteristics



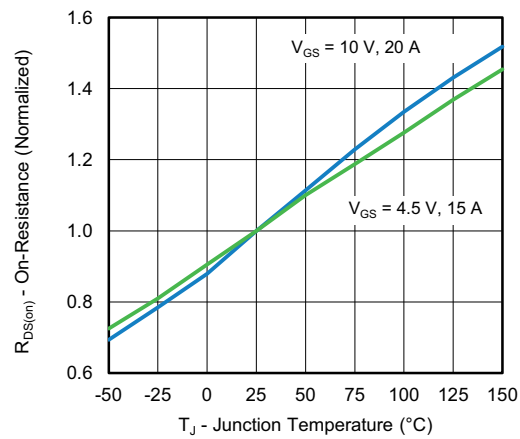
On-Resistance vs. Drain Current and Gate Voltage



Capacitance



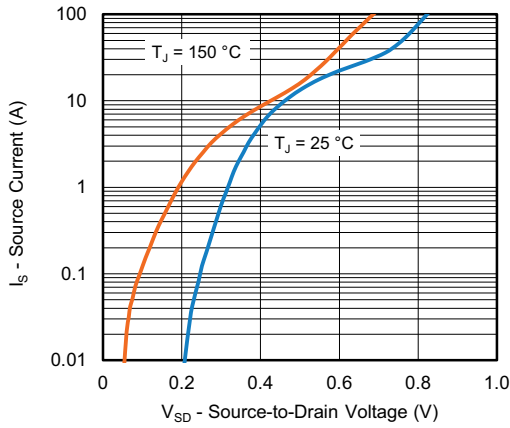
Gate Charge



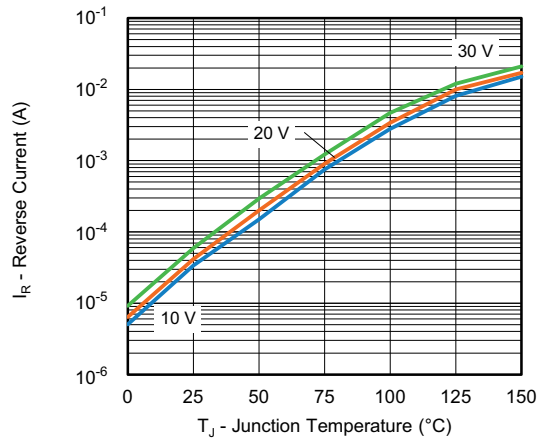
On-Resistance vs. Junction Temperature



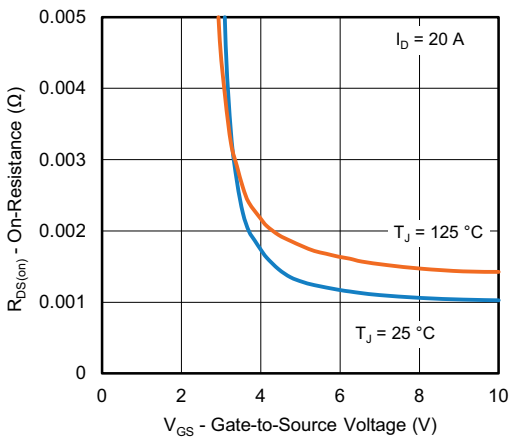
**TYPICAL CHARACTERISTICS** (25 °C, unless otherwise noted)



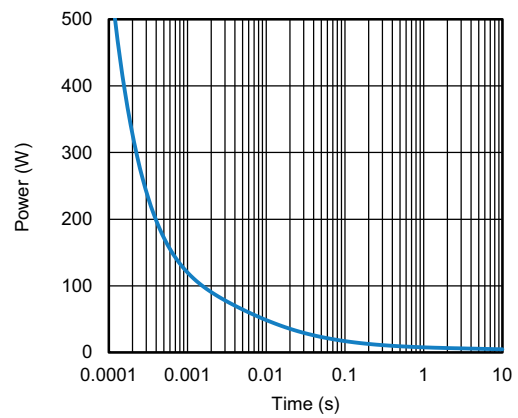
**Source-Drain Diode Forward Voltage**



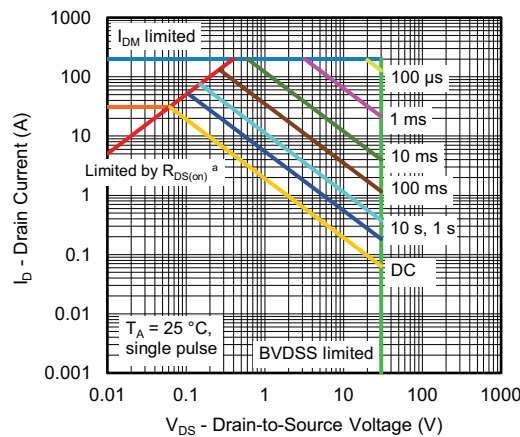
**Reverse Current (Schottky)**



**On-Resistance vs. Gate-to-Source Voltage**



**Single Pulse Power, Junction-to-Ambient**



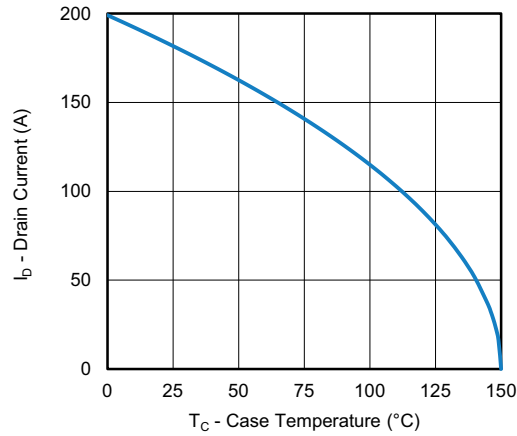
**Safe Operating Area, Junction-to-Ambient**

**Note**

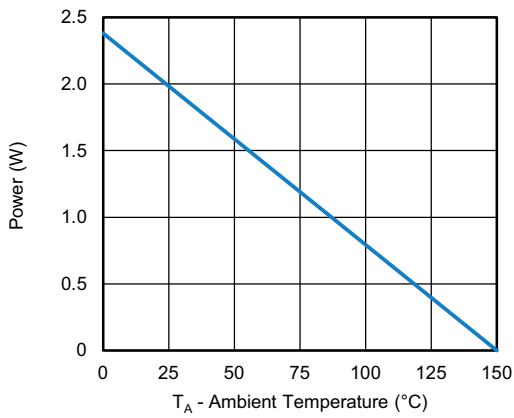
a.  $V_{GS} >$  minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified



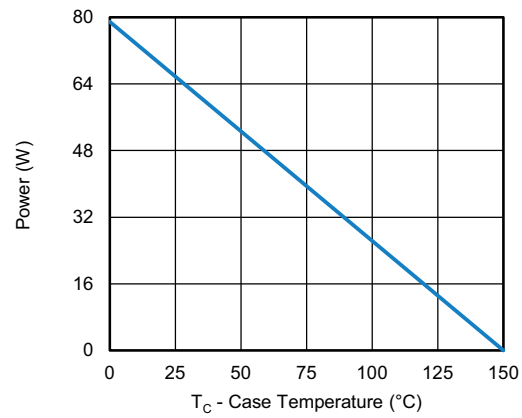
**TYPICAL CHARACTERISTICS** (25 °C, unless otherwise noted)



**Current Derating <sup>a</sup>**



**Power, Junction-to-Ambient**



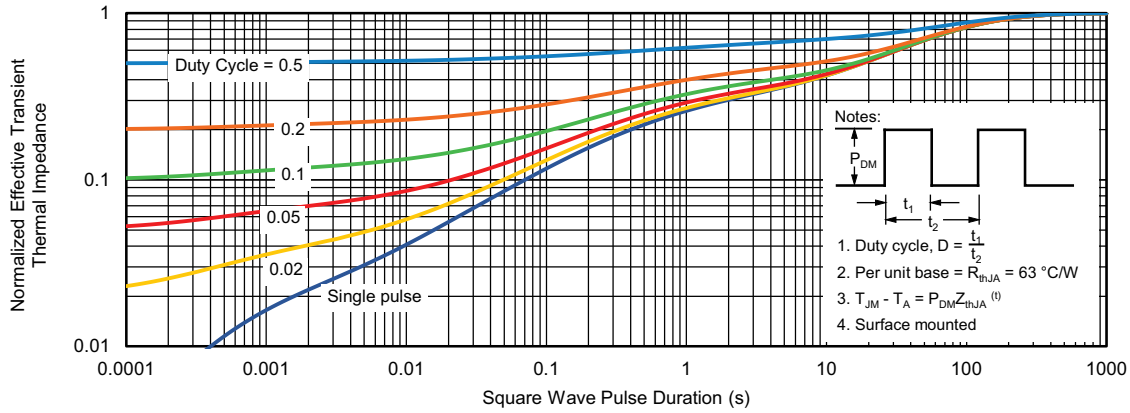
**Power, Junction-to-Case**

**Note**

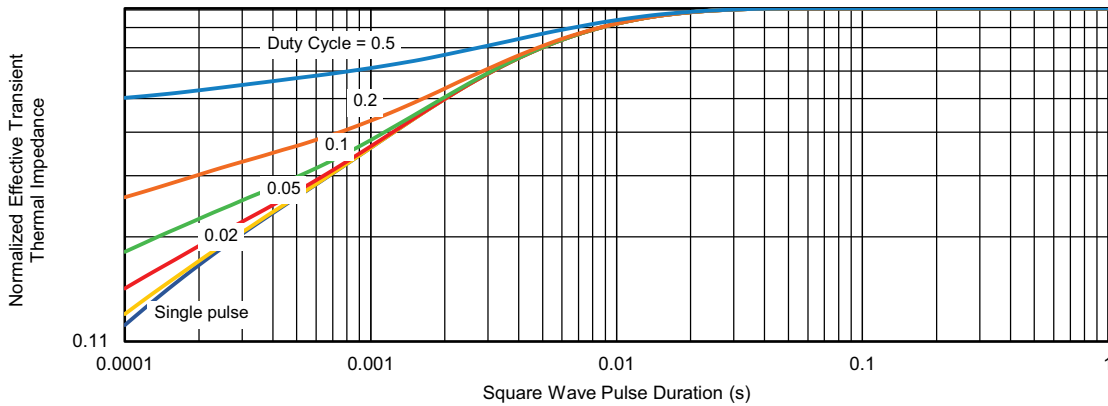
- a. The power dissipation  $P_D$  is based on  $T_J$  max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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## Case Outline for PowerPAK® 1212-8S



DIM.	MILLIMETERS			INCHES		
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
A	0.67	0.75	0.83	0.026	0.030	0.033
A1	0.00	-	0.05	0.000	-	0.002
A3	0.20 ref.			0.008 ref.		
b	0.25	0.30	0.35	0.010	0.012	0.014
D	3.20	3.30	3.40	0.126	0.130	0.134
D1	2.15	2.25	2.35	0.085	0.089	0.093
E	3.20	3.30	3.40	0.126	0.130	0.134
E1	1.60	1.70	1.80	0.063	0.067	0.071
e	0.65 bsc.			0.026 bsc.		
K	0.76 ref.			0.030 ref.		
K1	0.41 ref.			0.016 ref.		
L	0.33	0.43	0.53	0.013	0.017	0.021
Z	0.525 ref.			0.021 ref.		

ECN: C20-0862-Rev. B, 20-Jul-2020  
DWG: 6008

## RECOMMENDED MINIMUM PADS FOR PowerPAK® 1212-8 Single



Recommended Minimum Pads  
Dimensions in Inches/(mm)

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